Renesas Electronics America Inc - R5F5210ABDFB#30 Datasheet

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	EBI/EMI, I²C, SCI, SPI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	122
Program Memory Size	768KB (768K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	96K x 8
Voltage - Supply (Vcc/Vdd)	1.62V ~ 5.5V
Data Converters	A/D 16x12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LFQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f5210abdfb-30

Table 1.1 Outline of Specifications (4 / 5)

Classification	Module/Function	Description
Communication functions	Serial communications interfaces (SCIc, SCId)	• 13 channels (channel 0 to 11: SCIc, channel 12: SCId) • Serial communications modes: Asynchronous, clock synchronous, and smart-card interface • On-chip baud rate generator allows selection of the desired bit rate • Choice of LSB-first or MSB-first transfer • Average transfer rate clock can be input from TMR timers (SCI5, SCI6, and SCI12) • Simple IIC • Simple SPI • Master/slave mode supported (SCId only) • Start frame and information frame are included (SCId only)
	I^2C bus interface (RIIC)	• 1 channel • Communications formats: I^2C bus format/SMBus format • Master/slave selectable • Supports the fast mode
	Serial peripheral interface (RSPI)	• 1 channel • Transfer facility Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPI clock (RSPCK) signals enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines) • Capable of handling serial transfer as a master or slave • Data formats • Choice of LSB-first or MSB-first transfer The number of bits in each transfer can be changed to any number of bits from 8 to 16, 20, 24, or 32 bits. 128-bit buffers for transmission and reception Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits) • Double buffers for both transmission and reception
12-bit A/D converter (S12ADb)		• 12 bits (16 channels × 1 unit) • 12-bit resolution • Minimum conversion time: 1.0 μs per channel (in operation with ADCLK at 50 MHz) • Operating modes Scan mode (single scan mode, continuous scan mode, and group scan mode) • Sample-and-hold function • Self-diagnosis for the A/D converter • Assistance in detecting disconnected analog inputs • Double-trigger mode (duplication of A/D conversion data) • A/D conversion start conditions A software trigger, a trigger from a timer (MTU), an external trigger signal, or ELC
Temperature sensor (TEMPSa)		• Outputs the voltage that changes depending on the temperature • PGA gain switchable: Four levels according to the voltage range
D/A converter (DA)		• 2 channels • 10-bit resolution • Output voltage: 0 V to VREFH
CRC calculator (CRC)		• CRC code generation for arbitrary amounts of data in 8-bit units • Select any of three generating polynomials: $X^8 + X^2 + X + 1$, $X^{16} + X^{15} + X^2 + 1$, or $X^{16} + X^{12} + X^5 + 1$ • Generation of CRC codes for use with LSB-first or MSB-first communications is selectable.
Comparator A (CMPA)		• 2 channels • Comparison of reference voltage and analog input voltage
Comparator B (CMPB)		• 2 channels • Comparison of reference voltage and analog input voltage
Data Operation Circuit (DOC)		Comparison, addition, and subtraction of 16-bit data
Power supply voltage/Operating frequency		VCC = 1.62 to 1.8 V: 20 MHz, VCC = 1.8 to 2.7 V: 32 MHz, VCC = 2.7 to 5.5 V: 50 MHz
Operating temperature		D version: −40 to +85°C, G version: −40 to +105°C*2

1.5 Pin Assignments

Figure 1.3 to Figure 1.11 show the pin assignments. Table 1.9 to Table 1.17 show the lists of pins and pin functions.

	A	B	C	D	E	F	G	H	J	K	L	M	N	
13	PE3	PE4	PK4	PE6	P67	PA2	PA4	PA7	PB1	PB5	PL0	PL1	P74	13
12	PE1	PE2	P70	PE5	P65	PA1	VCC	PB0	PB2	PB6	P73	PC1	P75	12
11	P62	P61	PE0	PK5	P66	VSS	PA6	P71	PB4	PB7	PC2	PC0	PC3	11
10	PK3	PK2	P63	PE7	PA0	PA3	PA5	P72	PB3	P76	PC4	P77	P82	10
9	PD6	PD4	PD7	P64						P80	PC5	P81	PC7	9
8	PD2	PD0	PD3	P60						VCC	P83	PC6	VSS	8
7	P92	P91	PD1	PD5						P51	P52	P50	P55	7
6	P90	P47	VSS	P93						P53	P56	PH0	PH1	6
5	P45	P43	P46	VCC	P44					P54	P13	PH3	PH2	5
4	P42	VREFL0	P41	P01	NC	PJ1	NC	P35	P30	P15	P24	P12	P14	4
3	P40	P05	VREFH0	P03	PJ5	PJ3	MD	VSS	P32	P31	P16	P86	P87	3
2	P07	AVCC0	P02	PF5	VCL	XCOUT	RES#	VCC	P33	P26	P23	P17	P20	2
1	AVSS0	VREFH	VREFL	P00	VSS	XCIN	XTAL	EXTAL	P34	P27	P25	P22	P21	1
	A	B	C	D	E	F	G	H	J	K	L	M	N	

RX210 Group
PTLG0145KA-A
(145-pin TFLGA)
(Upper perspective view)

Note: • This figure indicates the power supply pins and I/O port pins. For the pin configuration, see the table “List of Pins and Pin Functions (145-Pin TFLGA)”.
Note: • For the position of A1 pin in the package, see “Package Dimensions”.

Figure 1.3 Pin Assignments of the 145-Pin TFLGA (Upper Perspective View)

Table 1.13 List of Pins and Pin Functions (80-Pin LQFP) (1 / 2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, TMR, POE)	Communications (SCIc, SCId, RSPI, RIIC)	Others
1	VREFH				
2		P03			DA0
3	VREFL				
4	VCL				
5		PJ1	MTIOC3A		
6	MD				FINED
7	XCIN				
8	XCOUT				
9	RES#				
10	XTAL	P37			
11	VSS				
12	EXTAL	P36			
13	VCC				
14		P35			NMI
15		P34	MTIOC0A/TMCI3/POE2#	SCK6	IRQ4
16		P32	MTIOC0C/TMO3	TXD6/SMOSI6/SSDA6	IRQ2-DS/RTCOUT/ RTCIC2
17		P31	MTIOC4D/TMCI2	CTS1#/RTS1#/SS1#	IRQ1-DS/RTCIC1
18		P30	MTIOC4B/TMRI3/POE8#	RXD1/SMISO1/SSCL1	IRQ0-DS/RTCIC0
19		P27	MTIOC2B/TMCI3	SCK1	
20		P26	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1	
21		P21	MTIOC1B/TMCI0	RXD0/SSCL0	
22		P20	MTIOC1A/TMRI0	TXD0/SSDA0	
23		P17	MTIOC3A/MTIOC3B/TMO1/ POE8#	SCK1/MISOA/ SDA-DS	IRQ7
24		P16	MTIOC3C/MTIOC3D/TMO2	TXD1/SMOSI1/SSDA1/MOSIA/ SCL-DS	IRQ6/RTCOUT/ ADTRG0#
25		P15	MTIOC0B/MTCLKB/TMCI2	RXD1/SMISO1/SSCL1	IRQ5
26		P14	MTIOC3A/MTCLKA/TMRI2	CTS1#/RTS1#/SS1#	IRQ4
27		P13	MTIOC0B/TMO3	SDA	IRQ3
28		P12	TMCI1	SCL	IRQ2
29		PH3	TMCI0		
30		PH2	TMRI0		IRQ1
31		PH1	TMO0		IRQ0
32		PH0			CACREF
33		P55	MTIOC4D/TMO3		
34		P54	MTIOC4B/TMCI1		
35		PC7	MTIOC3A/TMO2/MTCLKB	TXD8/SMOSI8/SSDA8/MISOA	CACREF
36		PC6	MTIOC3C/MTCLKA/TMCI2	RXD8/SMISO8/SSCL8/MOSIA	
37		PC5	MTIOC3B/MTCLKD/TMRI2	SCK8/RSPCKA	
38		PC4	MTIOC3D/MTCLKC/TMCI1/ POE0#	SCK5/CTS8#/RTS8#/SS8#/ SSLA0	
39		PC3	MTIOC4D	TXD5/SMOSI5/SSDA5	
40		PC2	MTIOC4B	RXD5/SMISO5/SSCL5/SSLA3	
41		PB7	MTIOC3B	TXD9/SMOSI9/SSDA9	
42		PB6	MTIOC3D	RXD9/SMISO9/SSCL9	
43		PB5	MTIOC2A/MTIOC1B/TMRI1/ POE1#	SCK9	
44		PB4		CTS9#/RTS9#/SS9#	

Table 1.16 List of Pins and Pin Functions (64-Pin LQFP) (1 / 2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, TMR, POE)	Communication (SCIc, SCId, RSPI, RIIC)	Others
1		P03			DA0
2	VCL				
3	MD				FINED
4	XCIN				
5	XCOUT				
6	RES#				
7	XTAL	P37			
8	VSS				
9	EXTAL	P36			
10	VCC				
11		P35			NMI
12		P32	MTIOC0C/TMO3	TXD6/SMOSI6/SSDA6	IRQ2-DS/RTCOUT/ RTCIC2
13		P31	MTIOC4D/TMCI2	CTS1#/RTS1#/SS1#	IRQ1-DS/RTCIC1
14		P30	MTIOC4B/TMRI3/POE8#	RXD1/SMISO1/SSCL1	IRQ0-DS/RTCIC0
15		P27	MTIOC2B/TMCI3	SCK1	
16		P26	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1	
17		P17	MTIOC3A/MTIOC3B/TMO1/ POE8#	SCK1/MISOA/SDA-DS	IRQ7
18		P16	MTIOC3C/MTIOC3D/TMO2	TXD1/SMOSI1/SSDA1/MOSIA/ SCL-DS	IRQ6/RTCOUT/ ADTRG0#
19		P15	MTIOC0B/MTCLKB/TMCI2	RXD1/SMISO1/SSCL1	IRQ5
20		P14	MTIOC3A/MTCLKA/TMRI2	CTS1#/RTS1#/SS1#	IRQ4
21		PH3	TMCI0		
22		PH2	TMRI0		IRQ1
23		PH1	TMO0		IRQ0
24		PH0			CACREF
25		P55	MTIOC4D/TMO3		
26		P54	MTIOC4B/TMCI1		
27		PC7	MTIOC3A/TMO2/MTCLKB	TXD8/SMOSI8/SSDA8/MISOA	CACREF
28		PC6	MTIOC3C/MTCLKA/TMCI2	RXD8/SMISO8/SSCL8/MOSIA	
29		PC5	MTIOC3B/MTCLKD/TMRI2	SCK8/RSPCKA	
30		PC4	MTIOC3D/MTCLKC/TMCI1/ POE0#	SCK5/CTS8#/RTS8#/SS8#/ SSLA0	
31		PC3	MTIOC4D	TXD5/SMOSI5/SSDA5	
32		PC2	MTIOC4B	RXD5/SMISO5/SSCL5/SSLA3	
33		PB7	MTIOC3B	TXD9/SMOSI9/SSDA9	
34		PB6	MTIOC3D	RXD9/SMISO9/SSCL9	
35		PB5	MTIOC2A/MTIOC1B/TMRI1/ POE1#	SCK9	
36		PB3	MTIOC0A/MTIOC4A/TMO0/ POE3#	SCK6	
37		PB1	MTIOC0C/MTIOC4C/TMCI0	TXD6/SMOSI6/SSDA6	IRQ4-DS
38	VCC				
39		PB0	MTIC5W	RXD6/SMISO6/SSCL6/RSPCKA	
40	VSS				
41		PA6	MTIC5V/MTCLKB/TMCI3/ POE2#	CTS5#/RTS5#/SS5#/MOSIA	
42		PA4	MTIC5U/MTCLKA/TMRI0	TXD5/SMOSI5/SSDA5/SSLA0	IRQ5-DS/CVREFB1
43		PA3	MTIOC0D/MTCLKD	RXD5/SMISO5/SSCL5	IRQ6-DS/CMPB1

Table 4.1 List of I/O Registers (Address Order) (3 / 29)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles ICLK ≥ PCLK	Number of Access Cycles ICLK < PCLK
0008 3032h	BSC	CS3 mode register	CS3MOD	16	16	1, 2 BCLK	
0008 3034h	BSC	CS3 wait control register 1	CS3WCR1	32	32	1, 2 BCLK	
0008 3038h	BSC	CS3 wait control register 2	CS3WCR2	32	32	1, 2 BCLK	
0008 3802h	BSC	CS0 control register	CS0CR	16	16	1, 2 BCLK	
0008 380Ah	BSC	CS0 recovery cycle register	CS0REC	16	16	1, 2 BCLK	
0008 3812h	BSC	CS1 control register	CS1CR	16	16	1, 2 BCLK	
0008 381Ah	BSC	CS1 recovery cycle register	CS1REC	16	16	1, 2 BCLK	
0008 3822h	BSC	CS2 control register	CS2CR	16	16	1, 2 BCLK	
0008 382Ah	BSC	CS2 recovery cycle register	CS2REC	16	16	1, 2 BCLK	
0008 3832h	BSC	CS3 control register	CS3CR	16	16	1, 2 BCLK	
0008 383Ah	BSC	CS3 recovery cycle register	CS3REC	16	16	1, 2 BCLK	
0008 3880h	BSC	CS recovery cycle insertion enable register	CSRECEN	16	16	1, 2 BCLK	
0008 7010h	ICU	Interrupt request register 016	IR016	8	8	2 ICLK	
0008 7015h	ICU	Interrupt request register 021	IR021	8	8	2 ICLK	
0008 7017h	ICU	Interrupt request register 023	IR023	8	8	2 ICLK	
0008 701Bh	ICU	Interrupt request register 027	IR027	8	8	2 ICLK	
0008 701Ch	ICU	Interrupt request register 028	IR028	8	8	2 ICLK	
0008 701Dh	ICU	Interrupt request register 029	IR029	8	8	2 ICLK	
0008 701Eh	ICU	Interrupt request register 030	IR030	8	8	2 ICLK	
0008 701Fh	ICU	Interrupt request register 031	IR031	8	8	2 ICLK	
0008 7020h	ICU	Interrupt request register 032	IR032	8	8	2 ICLK	
0008 7021h	ICU	Interrupt request register 033	IR033	8	8	2 ICLK	
0008 7022h	ICU	Interrupt request register 034	IR034	8	8	2 ICLK	
0008 702Ch	ICU	Interrupt request register 044	IR044	8	8	2 ICLK	
0008 702Dh	ICU	Interrupt request register 045	IR045	8	8	2 ICLK	
0008 702Eh	ICU	Interrupt request register 046	IR046	8	8	2 ICLK	
0008 702Fh	ICU	Interrupt request register 047	IR047	8	8	2 ICLK	
0008 7039h	ICU	Interrupt request register 057	IR057	8	8	2 ICLK	
0008 703Ah	ICU	Interrupt request register 058	IR058	8	8	2 ICLK	
0008 703Bh	ICU	Interrupt request register 059	IR059	8	8	2 ICLK	
0008 703Fh	ICU	Interrupt request register 063	IR063	8	8	2 ICLK	
0008 7040h	ICU	Interrupt request register 064	IR064	8	8	2 ICLK	
0008 7041h	ICU	Interrupt request register 065	IR065	8	8	2 ICLK	
0008 7042h	ICU	Interrupt request register 066	IR066	8	8	2 ICLK	
0008 7043h	ICU	Interrupt request register 067	IR067	8	8	2 ICLK	
0008 7044h	ICU	Interrupt request register 068	IR068	8	8	2 ICLK	
0008 7045h	ICU	Interrupt request register 069	IR069	8	8	2 ICLK	
0008 7046h	ICU	Interrupt request register 070	IR070	8	8	2 ICLK	
0008 7047h	ICU	Interrupt request register 071	IR071	8	8	2 ICLK	
0008 7058h	ICU	Interrupt request register 088	IR088	8	8	2 ICLK	
0008 7059h	ICU	Interrupt request register 089	IR089	8	8	2 ICLK	
0008 705Ch	ICU	Interrupt request register 092	IR092	8	8	2 ICLK	
0008 705Dh	ICU	Interrupt request register 093	IR093	8	8	2 ICLK	
0008 7066h	ICU	Interrupt request register 102	IR102	8	8	2 ICLK	
0008 7067h	ICU	Interrupt request register 103	IR103	8	8	2 ICLK	
0008 706Ah	ICU	Interrupt request register 106	IR106	8	8	2 ICLK	
0008 706Bh	ICU	Interrupt request register 107	IR107	8	8	2 ICLK	
0008 7072h	ICU	Interrupt request register 114	IR114	8	8	2 ICLK	
0008 7073h	ICU	Interrupt request register 115	IR115	8	8	2 ICLK	
0008 7074h	ICU	Interrupt request register 116	IR116	8	8	2 ICLK	
0008 7075h	ICU	Interrupt request register 117	IR117	8	8	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (12 / 29)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles: ICLK ≥ PCLK	Number of Access Cycles: ICLK < PCLK
0008 8122h	TPU1	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK
0008 8124h	TPU1	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK
0008 8125h	TPU1	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK
0008 8126h	TPU1	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK
0008 8128h	TPU1	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK
0008 812Ah	TPU1	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK
0008 8130h	TPU2	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK
0008 8131h	TPU2	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK
0008 8132h	TPU2	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK
0008 8134h	TPU2	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK
0008 8135h	TPU2	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK
0008 8136h	TPU2	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK
0008 8138h	TPU2	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK
0008 813Ah	TPU2	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK
0008 8140h	TPU3	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK
0008 8141h	TPU3	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK
0008 8142h	TPU3	Timer I/O control register H	TIORH	8	8	2, 3 PCLKB	2 ICLK
0008 8143h	TPU3	Timer I/O control register L	TIORL	8	8	2, 3 PCLKB	2 ICLK
0008 8144h	TPU3	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK
0008 8145h	TPU3	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK
0008 8146h	TPU3	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK
0008 8148h	TPU3	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK
0008 814Ah	TPU3	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK
0008 814Ch	TPU3	Timer general register C	TGRC	16	16	2, 3 PCLKB	2 ICLK
0008 814Eh	TPU3	Timer general register D	TGRD	16	16	2, 3 PCLKB	2 ICLK
0008 8150h	TPU4	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK
0008 8151h	TPU4	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK
0008 8152h	TPU4	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK
0008 8154h	TPU4	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK
0008 8155h	TPU4	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK
0008 8156h	TPU4	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK
0008 8158h	TPU4	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK
0008 815Ah	TPU4	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK
0008 8160h	TPU5	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK
0008 8161h	TPU5	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK
0008 8162h	TPU5	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK
0008 8164h	TPU5	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK
0008 8165h	TPU5	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK
0008 8166h	TPU5	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK
0008 8168h	TPU5	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK
0008 816Ah	TPU5	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK
0008 8200h	TMR0	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK
0008 8201h	TMR1	Timer counter control register	TCR	8	8	2, 3 PCLKB	2 ICLK
0008 8202h	TMR0	Timer control/status register	TCSR	8	8	2, 3 PCLKB	2 ICLK
0008 8203h	TMR1	Timer control/status register	TCSR	8	8	2, 3 PCLKB	2 ICLK
0008 8204h	TMR0	Time constant register A	TCORA	8	8	2, 3 PCLKB	2 ICLK
0008 8205h	TMR1	Time constant register A	TCORA	8	8*1	2, 3 PCLKB	2 ICLK
0008 8206h	TMR0	Time constant register B	TCORB	8	8	2, 3 PCLKB	2 ICLK
0008 8207h	TMR1	Time constant register B	TCORB	8	8*1	2, 3 PCLKB	2 ICLK
0008 8208h	TMR0	Timer counter	TCNT	8	8	2, 3 PCLKB	2 ICLK
0008 8209h	TMR1	Timer counter	TCNT	8	8*1	2, 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (16 / 29)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles: ICLK ≥ PCLK	Number of Access Cycles: ICLK < PCLK
0008 8896h	MTU5	Timer I/O control register V	TIORV	8	8	2, 3 PCLKB	2 ICLK
0008 88A0h	MTU5	Timer counter W	TCNTW	16	16	2, 3 PCLKB	2 ICLK
0008 88A2h	MTU5	Timer general register W	TGRW	16	16	2, 3 PCLKB	2 ICLK
0008 88A4h	MTU5	Timer control register W	TCRW	8	8	2, 3 PCLKB	2 ICLK
0008 88A6h	MTU5	Timer I/O control register W	TIORW	8	8	2, 3 PCLKB	2 ICLK
0008 88B2h	MTU5	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK
0008 88B4h	MTU5	Timer start register	TSTR	8	8	2, 3 PCLKB	2 ICLK
0008 88B6h	MTU5	Timer compare match clear register	TCNTCMPCLR	8	8	2, 3 PCLKB	2 ICLK
0008 8900h	POE	Input level control/status register 1	ICSR1	16	8, 16	2, 3 PCLKB	2 ICLK
0008 8902h	POE	Output level control/status register 1	OCSR1	16	8, 16	2, 3 PCLKB	2 ICLK
0008 8908h	POE	Input level control/status register 2	ICSR2	16	8, 16	2, 3 PCLKB	2 ICLK
0008 890Ah	POE	Software port output enable register	SPOER	8	8	2, 3 PCLKB	2 ICLK
0008 890Bh	POE	Port output enable control register 1	POECR1	8	8	2, 3 PCLKB	2 ICLK
0008 890Ch	POE	Port output enable control register 2	POECR2	8	8	2, 3 PCLKB	2 ICLK
0008 890Eh	POE	Input level control/status register 3	ICSR3	16	8, 16	2, 3 PCLKB	2 ICLK
0008 9000h	S12AD	A/D control register	ADCSR	16	16	2, 3 PCLKB	2 ICLK
0008 9004h	S12AD	A/D channel select register A	ADANSA	16	16	2, 3 PCLKB	2 ICLK
0008 9008h	S12AD	A/D-converted value addition mode select register	ADADS	16	16	2, 3 PCLKB	2 ICLK
0008 900Ch	S12AD	A/D-converted value addition count select register	ADADC	8	8	2, 3 PCLKB	2 ICLK
0008 900Eh	S12AD	A/D control extended register	ADCER	16	16	2, 3 PCLKB	2 ICLK
0008 9010h	S12AD	A/D start trigger select register	ADSTRGR	16	16	2, 3 PCLKB	2 ICLK
0008 9012h	S12AD	A/D converted extended input control register	ADEXICR	16	16	2, 3 PCLKB	2 ICLK
0008 9014h	S12AD	A/D channel select register B	ADANSB	16	16	2, 3 PCLKB	2 ICLK
0008 9018h	S12AD	A/D double register	ADDBLDR	16	16	2, 3 PCLKB	2 ICLK
0008 901Ah	S12AD	A/D temperature sensor data register	ADTSDR	16	16	2, 3 PCLKB	2 ICLK
0008 901Ch	S12AD	A/D internal reference voltage data register	ADOCDR	16	16	2, 3 PCLKB	2 ICLK
0008 901Eh	S12AD	A/D self-diagnosis data register	ADRD	16	16	2, 3 PCLKB	2 ICLK
0008 9020h	S12AD	A/D data register 0	ADDR0	16	16	2, 3 PCLKB	2 ICLK
0008 9022h	S12AD	A/D data register 1	ADDR1	16	16	2, 3 PCLKB	2 ICLK
0008 9024h	S12AD	A/D data register 2	ADDR2	16	16	2, 3 PCLKB	2 ICLK
0008 9026h	S12AD	A/D data register 3	ADDR3	16	16	2, 3 PCLKB	2 ICLK
0008 9028h	S12AD	A/D data register 4	ADDR4	16	16	2, 3 PCLKB	2 ICLK
0008 902Ah	S12AD	A/D data register 5	ADDR5	16	16	2, 3 PCLKB	2 ICLK
0008 902Ch	S12AD	A/D data register 6	ADDR6	16	16	2, 3 PCLKB	2 ICLK
0008 902Eh	S12AD	A/D data register 7	ADDR7	16	16	2, 3 PCLKB	2 ICLK
0008 9030h	S12AD	A/D data register 8	ADDR8	16	16	2, 3 PCLKB	2 ICLK
0008 9032h	S12AD	A/D data register 9	ADDR9	16	16	2, 3 PCLKB	2 ICLK
0008 9034h	S12AD	A/D data register 10	ADDR10	16	16	2, 3 PCLKB	2 ICLK
0008 9036h	S12AD	A/D data register 11	ADDR11	16	16	2, 3 PCLKB	2 ICLK
0008 9038h	S12AD	A/D data register 12	ADDR12	16	16	2, 3 PCLKB	2 ICLK
0008 903Ah	S12AD	A/D data register 13	ADDR13	16	16	2, 3 PCLKB	2 ICLK
0008 903Ch	S12AD	A/D data register 14	ADDR14	16	16	2, 3 PCLKB	2 ICLK
0008 903Eh	S12AD	A/D data register 15	ADDR15	16	16	2, 3 PCLKB	2 ICLK
0008 9060h	S12AD	A/D sampling state register 0	ADSSTR0	8	8	2, 3 PCLKB	2 ICLK
0008 9061h	S12AD	A/D sampling state register L	ADSSTRL	8	8	2, 3 PCLKB	2 ICLK
0008 9066h	S12AD	A/D sample and hold circuit register	ADSHCR	16	16	2, 3 PCLKB	2 ICLK
0008 9070h	S12AD	A/D sampling state register T	ADSSTRT	8	8	2, 3 PCLKB	2 ICLK
0008 9071h	S12AD	A/D sampling state register O	ADSSTRO	8	8	2, 3 PCLKB	2 ICLK
0008 9073h	S12AD	A/D sampling state register 1	ADSSTR1	8	8	2, 3 PCLKB	2 ICLK
0008 9074h	S12AD	A/D sampling state register 2	ADSSTR2	8	8	2, 3 PCLKB	2 ICLK
0008 9075h	S12AD	A/D sampling state register 3	ADSSTR3	8	8	2, 3 PCLKB	2 ICLK

Table 5.4 DC Characteristics (3)

Conditions: VCC = AVCC0 = 1.62 to 5.5 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input leakage current	RES#, MD pin, P35/NMI	$\lvert I_{in} \rvert$	—	—	1.0	µA	V_{in} = 0 V, VCC
Three-state leakage current (off-state)	Port 4	$\lvert I_{TSI} \rvert$	—	—	1.0	µA	V_{in} = 0 V, VCC
	Other pins except for ports for 5 V tolerant and port 4		—	—	0.2		
	Ports for 5 V tolerant		—	—	1.0		V_{in} = 0 V, 5.8 V
Input capacitance	All input pins (except for ports 12, 13, 16, 17, 4, A1, A3, A4, and E)	C_{in}	—	—	15	pF	V_{in} = 0 V, f = 1 MHz, T_a = 25°C
	Ports 12, 13, 16, 17, 4, A1, A3, A4, and E		—	—	30		

Table 5.5 DC Characteristics (4)

Conditions: VCC = AVCC0 = 1.62 to 5.5 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C

Item		Symbol	VCC						Unit	Test Conditions
			1.62 to 2.7 V		2.7 to 4.0 V		4.0 to 5.5 V			
			Min.	Max.	Min.	Max.	Min.	Max.		
Input pull-up MOS current	All ports (except for port 35)	I_p	–150	–5	–200	–10	–400	–50	µA	V_{in} = 0 V

[Chip version A]

Table 5.6 DC Characteristics (5)

Conditions: VCC = AVCC0 = 2.7 to 5.5 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C

Item					Symbol	Typ.	Max.	Unit	Test Conditions
Supply current*1	High-speed operating mode	Normal operating mode	No peripheral operation*2	ICLK = 50 MHz	I_{CC}	10	—	mA	
			All peripheral operation: Normal*3	ICLK = 50 MHz		31.5	—		
			All peripheral operation: Max.*3	ICLK = 50 MHz		—	55		
		Sleep mode	No peripheral operation	ICLK = 50 MHz		7.5	—		
			All peripheral operation: Normal	ICLK = 50 MHz		17.5	—		
		All-module clock stop mode		ICLK = 50 MHz		6.7	—		
		Increase during BGO operation*4				25	—		

Note 1. Supply current values do not include output charge/discharge current from all pins. The values apply when internal pull-up MOSs are in the off state.

Note 2. Clock supply to the peripheral functions is stopped. This does not include BGO operation. The clock source is PLL and the VCO oscillation frequency is 100 MHz. BCLK, FCLK, and PCLK are set to divided by 64.

Note 3. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is PLL and the VCO oscillation frequency is 100 MHz. BCLK, FCLK, and PCLK are ICLK divided by 2.

Note 4. This is the increase if data is programmed to or erasing from the ROM or E2 DataFlash during program execution.

[Chip version C]

Table 5.9 DC Characteristics (8)

Conditions: VCC = AVCC0 = 2.7 to 5.5 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C

Item					Symbol	Typ.	Max.	Unit	Test Conditions
Supply current*1	High-speed operating mode	Normal operating mode	No peripheral operation*2	ICLK = 50 MHz	I_{CC}	10	—	mA	
			All peripheral operation: Normal*3	ICLK = 50 MHz		31.5	—		
			All peripheral operation: Max.*3	ICLK = 50 MHz		—	55		
		Sleep mode	No peripheral operation	ICLK = 50 MHz		7.5	—		
			All peripheral operation: Normal	ICLK = 50 MHz		17.5	—		
		All-module clock stop mode		ICLK = 50 MHz		6.7	—		
		Increase during BGO operation*4				25	—		

Note 1. Supply current values do not include output charge/discharge current from all pins. The values apply when internal pull-up MOSs are in the off state.

Note 2. Clock supply to the peripheral functions is stopped. This does not include BGO operation. The clock source is PLL and the VCO oscillation frequency is 100 MHz. BCLK, FCLK, and PCLK are set to divided by 64.

Note 3. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is PLL and the VCO oscillation frequency is 100 MHz. BCLK, FCLK, and PCLK are ICLK divided by 2.

Note 4. This is the increase if data is programmed to or erasing from the ROM or E2 DataFlash during program execution.

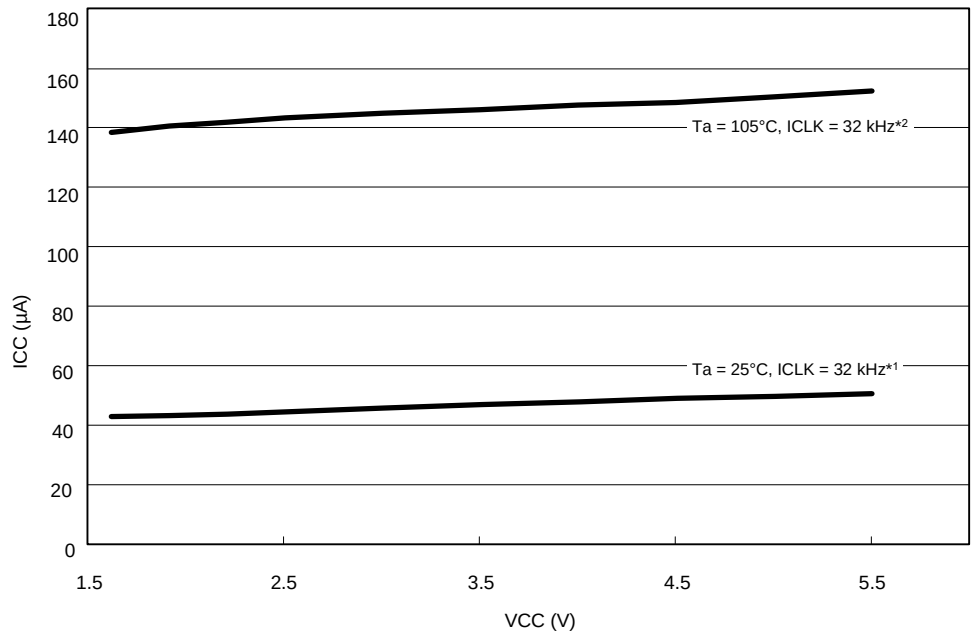
[Chip version B with 768 Kbytes/1 Mbyte of flash memory and 100 to 145 pins]

Table 5.17 DC Characteristics (16)

Conditions: VCC = AVCC0 = 1.62 to 5.5 V, VSS = AVSS0 = 0 V, T_a = –40 to +105°C

Item				Symbol	Typ.*3	Max.	Unit	Test Conditions
Supply current*1	Software standby mode*2	Flash memory power supplied, HOCO power supplied, POR low power consumption function disabled (SOFTCUT[2:0] bits = 000b)	T_a = 25°C	I_{CC}	10	34	µA	
			T_a = 55°C		13	87		
			T_a = 85°C		21	201		
			T_a = 105°C		40	352		
		Flash memory power supplied, HOCO power not supplied, POR low power consumption function enabled (SOFTCUT[2:0] bits = 110b)	T_a = 25°C		1.8	24		
			T_a = 55°C		3.3	70		
			T_a = 85°C		10	168		
			T_a = 105°C		25	302		
	Deep software standby mode*2	Flash memory power not supplied, HOCO power not supplied, POR low power consumption function enabled (DEEPCUT1 bit = 1)	T_a = 25°C		0.4	0.8		
			T_a = 55°C		0.5	1.0		
			T_a = 85°C		0.7	2.5		
			T_a = 105°C		1.4	6.3		
	Increments produced by running voltage detection circuits and disabling the POR low power consumption function				1.4	—		
	Increment for RTC operation (low CL)				0.8	—		
	Increment for RTC operation (standard CL)				2.0	—		

Note 1. Supply current values are with all output pins unloaded and all input pull-up MOSs in the off state.
Note 2. The IWDT and LVD are stopped.
Note 3. VCC = 3.3 V.



Note 1. All peripheral operation is normal.
Average value of the tested middle samples during product evaluation.
Note 2. All peripheral operation is maximum.
Average value of the tested upper-limit samples during product evaluation.

Figure 5.39 Voltage Dependency in Low-Speed Operating Mode 2 (Reference Data) for Chip Version B with 512 Kbytes or Less of Flash Memory and 144 and 145 Pins

Table 5.21 DC Characteristics (20)

Conditions: VCC = AVCC0 = 1.62 to 5.5 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C

Item	Symbol	Typ.	Max.	Unit	Test Conditions
Permissible total consumption power*1	Pd	—	350	mW	Ta = –40 to 85°C
		—	150		85°C < Ta ≤ 105°C

Note: • Please contact Renesas Electronics sales office for derating of operation under Ta = +85°C to +105°C. Derating is the systematic reduction of load for the sake of improved reliability.
Note 1. Total power dissipated by the entire chip (including output currents)

Table 5.22 DC Characteristics (21)

Conditions: VCC = AVCC0 = 1.62 to 5.5 V, VREFH = 1.8 to AVCC0, VREFH0 = 1.62 to AVCC0,
VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Analog power supply current	During A/D conversion	I_{AVCC0}	—	1.0	3.2	mA	
	Temperature sensor operating, waiting for A/D conversion		—	60	200	µA	
	During D/A conversion (per channel)	I_{VREFH}*1	—	0.25	0.75	mA	
	Waiting for A/D, D/A conversion (all units)*2	—	—	0.2	5.0	µA	
Reference power supply current	During A/D conversion	I_{VREFH0}	—	0.1	0.2	mA	
	Waiting for A/D conversion		—	0.2	0.4	µA	

Note: • The values for A/D conversion apply when the sample and hold circuit is not in use.
Note 1. The reference power supply current is included in the power supply current value for D/A conversion.
Note 2. The value is the total value of I_{AVCC0} and I_{VREFH}.

Table 5.23 DC Characteristics (22)

Conditions: VCC = AVCC0, VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
RAM standby voltage	V_{RAM}	1.62	—	—	V	

Table 5.24 DC Characteristics (23)

Conditions: VCC = AVCC0 = 0 to 5.5 V, VREFH = VREFH0 = 0 to AVCC0, VSS = AVSS0 = VREFL = VREFL0 = 0 V,
T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
VCC rising gradient	SrVCC	0.02	—	20	ms/V	At cold start

[Chip version B]

Table 5.39 Operation Frequency Value (Low-Speed Operating Mode 1)

Conditions: VCC = AVCC0 = 1.62 to 5.5 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C

Item		Symbol	VCC			Unit
			1.62 to 1.8 V	1.8 to 2.7 V	2.7 to 5.5 V	
Maximum operating frequency	System clock (ICLK)	f_{max}	2	4	8	MHz
	FlashIF clock (FCLK)*1		2	4	8	
	Peripheral module clock (PCLKB)		2	4	8	
	Peripheral module clock (PCLKD)*2		2	4	8	
	External bus clock (BCLK)		2	4	8	
	BCLK pin output		2	4	8	

Note 1. Programming and erasing the flash memory is impossible.
Note 2. The lower-limit frequency of PCLKD is 1 MHz when the A/D converter is in use.

[Chip versions A, B, and C]

Table 5.40 Operation Frequency Value (Low-Speed Operating Mode 2)

Conditions: VCC = AVCC0 = 1.62 to 5.5 V, VSS = AVSS0 = VREFL=VREFL0 = 0 V, T_a = –40 to +105°C

Item		Symbol	VCC			Unit
			1.62 to 1.8 V	1.8 to 2.7 V	2.7 to 5.5 V	
Maximum operating frequency	System clock (ICLK)	f_{max}	32.768	32.768	32.768	kHz
	FlashIF clock (FCLK)*1		32.768	32.768	32.768	
	Peripheral module clock (PCLKB)		32.768	32.768	32.768	
	Peripheral module clock (PCLKD)*2		32.768	32.768	32.768	
	External bus clock (BCLK)		32.768	32.768	32.768	
	BCLK pin output		32.768	32.768	32.768	

Note 1. Programming and erasing the flash memory is impossible.
Note 2. The A/D converter cannot be used.

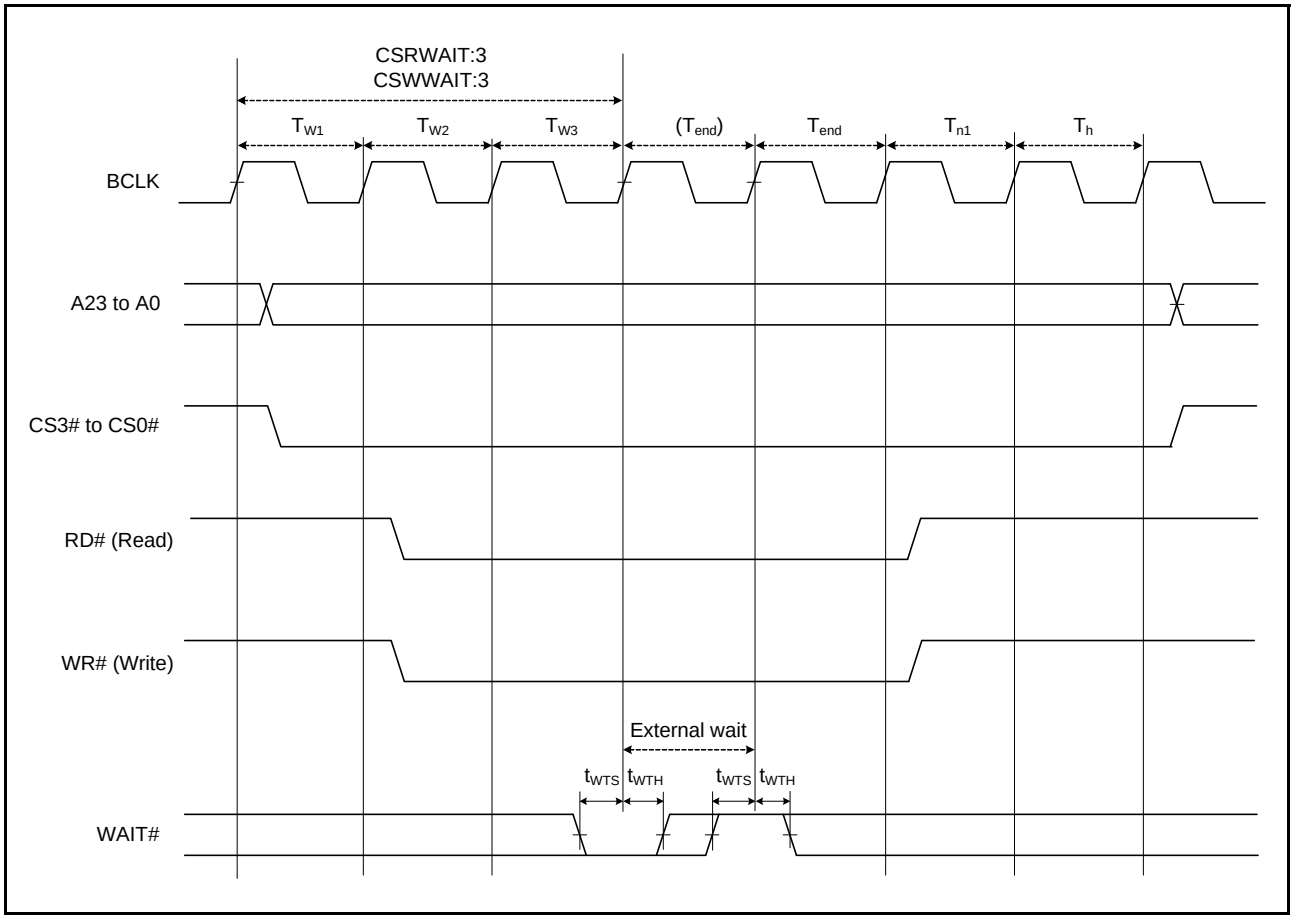


Figure 5.80 External Bus Timing/External Wait Control

5.3.6 Timing of On-Chip Peripheral Modules

Table 5.55 Timing of On-Chip Peripheral Modules (1)

Conditions: VCC = AVCC0 = 1.62 to 5.5 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C
When high-drive output is selected by the drive capacity register

Item				Symbol	Min.	Max.	Unit	Test Conditions
I/O ports	Input data pulse width			t_{PRW}	1.5	—	t_{Pcyc}	Figure 5.83
MTU/ TPU	Input capture input pulse width		Single-edge setting	t_{TICW}	1.5	—	t_{Pcyc}	Figure 5.84
			Both-edge setting		2.5	—		
	Timer clock pulse width		Single-edge setting	t_{TCKWH}, t_{TCKWL}	1.5	—	t_{Pcyc}	Figure 5.85
			Both-edge setting		2.5	—		
			Phase counting mode		2.5	—		
POE	POE# input pulse width			t_{POEW}	1.5	—	t_{Pcyc}	Figure 5.86
8-bit timer	Timer clock pulse width		Single-edge setting	t_{TMCWH}, t_{TMCWL}	1.5	—	t_{Pcyc}	Figure 5.87
			Both-edge setting		2.5	—		
SCI	Input clock cycle		Asynchronous	t_{Scyc}	4	—	t_{Pcyc}	Figure 5.88
			Clock synchronous		6	—		
	Input clock pulse width			t_{SCKW}	0.4	0.6	t_{Scyc}	
	Input clock rise time			t_{SCKr}	—	20	ns	
	Input clock fall time			t_{SCKf}	—	20	ns	
	Output clock cycle		Asynchronous	t_{Scyc}	16	—	t_{Pcyc}	C = 30 pF Figure 5.89
			Clock synchronous		4	—		
	Output clock pulse width		2.7 V ≤ VCC ≤ 5.5 V	t_{SCKW}	0.4	0.6	t_{Scyc}	
			1.8 V ≤ VCC < 2.7 V		0.35	0.65		
			1.62 V ≤ VCC < 1.8 V		0.35	0.65		
	Output clock rise time			t_{SCKr}	—	20	ns	
	Output clock fall time			t_{SCKf}	—	20	ns	
	Transmit data delay time (master)	Clock synchronous		t_{TXD}	—	40	ns	
	Transmit data delay time (slave)	Clock synchronous	2.7 V ≤ VCC ≤ 5.5 V		—	65	ns	
			1.8 V ≤ VCC < 2.7 V		—	85	ns	
			1.62 V ≤ VCC < 1.8 V		—	95	ns	
	Receive data setup time (master)	Clock synchronous	2.7 V ≤ VCC ≤ 5.5 V	t_{RXS}	65	—	ns	
			1.8 V ≤ VCC < 2.7 V		75	—	ns	
			1.62 V ≤ VCC < 1.8 V		80	—	ns	
	Receive data setup time (slave)	Clock synchronous			40	—	ns	
	Receive data hold time	Clock synchronous		t_{RXH}	40	—	ns	
A/D converter	Trigger input pulse width			t_{TRGW}	1.5	—	t_{Pcyc}	Figure 5.90
CAC	CACREF input pulse width		$t_{Pcyc} \le t_{cac}$*2	t_{CACREF}	4.5 t_{cac} + 3 t_{Pcyc}	—	ns	
			$t_{Pcyc} > t_{cac}$*2		5 t_{cac} + 6.5 t_{Pcyc}			

Note 1. t_{Pcyc}: PCLK cycle
Note 2. t_{cac}: CAC count clock source cycle

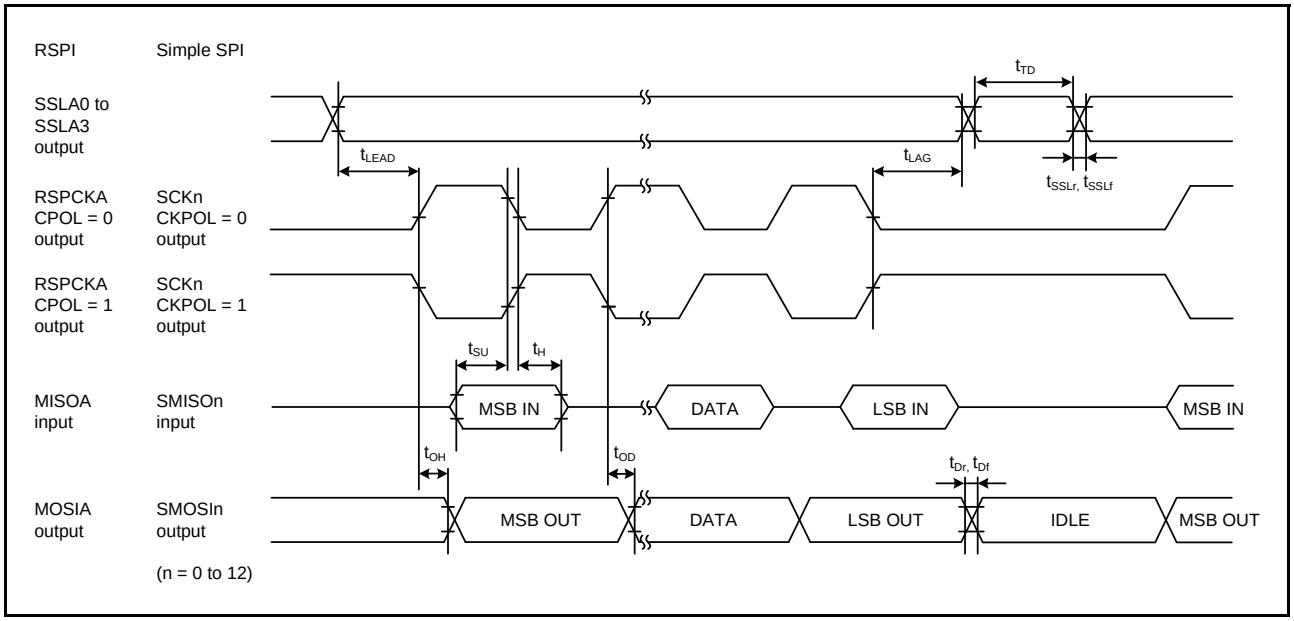


Figure 5.94 RSPI Timing (Master, CPHA = 1) (Bit Rate: PCLKB Set to Division Ratio Other Than Divided by 2) and Simple SPI Timing (Master, CKPH = 0)

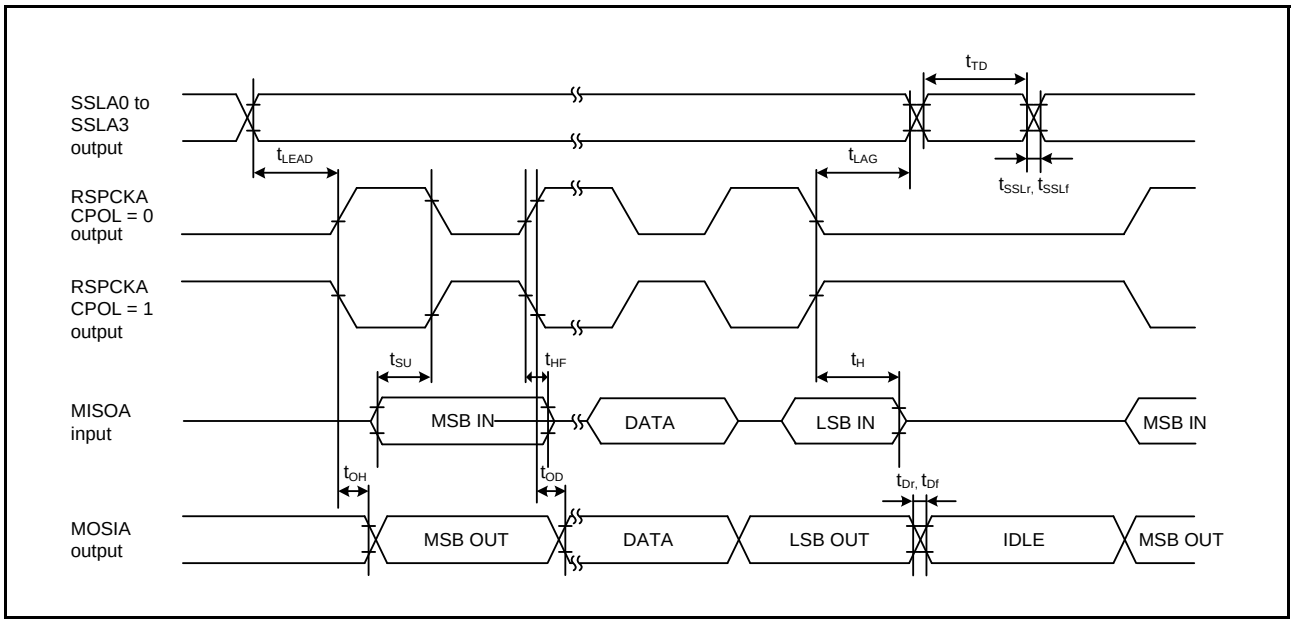


Figure 5.95 RSPI Timing (Master, CPHA = 1) (Bit Rate: PCLKB Set to Divided by 2)

5.5 D/A Conversion Characteristics

Table 5.67 D/A Conversion Characteristics (1)

Conditions: VCC = AVCC0 = 2.7 to 5.5 V, VREFH = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL = VREFL0 = 0 V, fPCLKB = up to 32 MHz, T_a = –40 to +105°C

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	—	—	10	Bit	
Conversion time	—	—	3.0	µs	20-pF capacitive load
Absolute accuracy	—	±3.0	±5.0	LSB	4-MΩ resistive load
	—	—	±4.0	LSB	8-MΩ resistive load
RO output resistance	—	4.1	—	kΩ	

Table 5.68 D/A Conversion Characteristics (2)

Conditions: VCC = AVCC0 = 2.7 to 5.5 V, VREFH =1.8 V to AVCC0,
VSS = AVSS0 = VREFL = VREFL0 = 0 V, fPCLKB = up to 32 MHz, T_a = –40 to +105°C

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	—	—	10	Bit	
Conversion time	—	—	10.0	µs	20-pF capacitive load
Absolute accuracy	—	±5.0	±6.0	LSB	4-MΩ resistive load
	—	—	±5.0	LSB	8-MΩ resistive load
RO output resistance	—	4.1	—	kΩ	

5.6 Temperature Sensor Characteristics

Table 5.69 Temperature Sensor Characteristics

Conditions: VCC = AVCC0 = VREFH0 = 1.8 to 5.5 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Relative accuracy		—	—	±1.0	—	°C	
Temperature slope	1.8 ≤ AVCC0 < 2.7	—	—	7.27	—	mV/°C	PGAGAIN = 00b
	2.7 ≤ AVCC0 < 3.6		—	10.46	—		PGAGAIN = 01b
	3.6 ≤ AVCC0 < 4.5		—	13.98	—		PGAGAIN = 10b
	4.5 ≤ AVCC0 ≤ 5.5		—	21.65	—		PGAGAIN = 11b
Output voltage (@ 25°C)		—	—	1.375	—	V	VCC = 3.6 V
Temperature sensor start time		t_{START}	—	—	80	µs	Figure 5.102
Sampling time		—	30	72	300	µs	
PGA restart time		t_{RST_PGA}	—	—	40	µs	

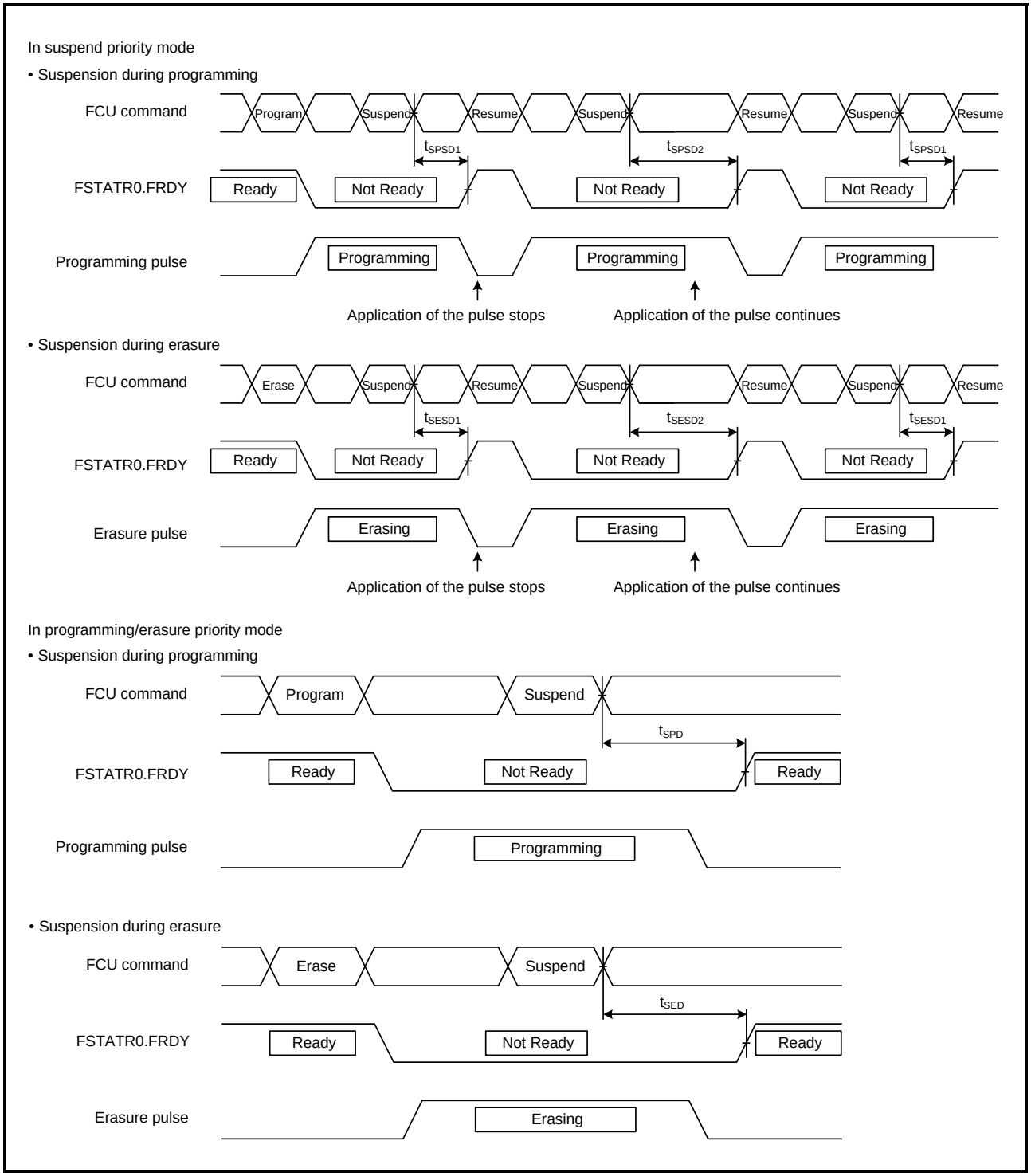
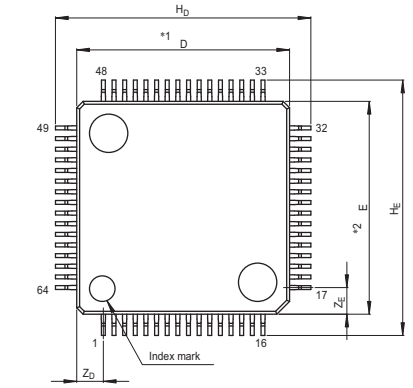
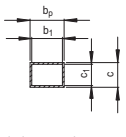
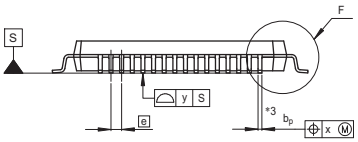


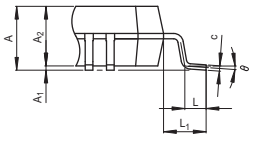
Figure 5.109 Flash Memory Program/Erase Suspend Timing

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LFQFP64-10x10-0.50	PLQP0064KB-A	64P6Q-A / FP-64K / FP-64KV	0.3g







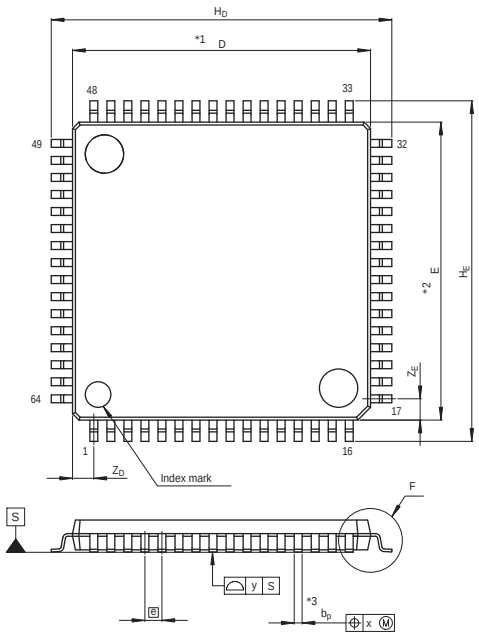


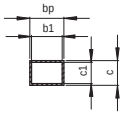
NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	9.9	10.0	10.1
E	9.9	10.0	10.1
A_2	—	1.4	—
H_D	11.8	12.0	12.2
H_E	11.8	12.0	12.2
A	—	—	1.7
A_1	0.05	0.1	0.15
b_p	0.15	0.20	0.25
b_1	—	0.18	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.5	—
x	—	—	0.08
y	—	—	0.08
Z_D	—	1.25	—
Z_E	—	1.25	—
L	0.35	0.5	0.65
L_1	—	1.0	—

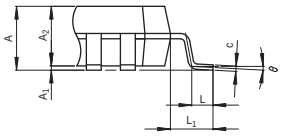
Figure J 64-Pin LQFP (PLQP0064KB-A)

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LQFP64-14x14-0.80	PLQP0064GA-A	64P6U-A/ —	0.7g





Terminal cross section



Detail F

NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	13.9	14.0	14.1
E	13.9	14.0	14.1
A_2	—	1.4	—
H_D	15.8	16.0	16.2
H_E	15.8	16.0	16.2
A	—	—	1.7
A_1	0	0.1	0.2
b_p	0.32	0.37	0.42
b_1	—	0.35	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.8	—
x	—	—	0.20
y	—	—	0.10
Z_D	—	1.0	—
Z_E	—	1.0	—
L	0.3	0.5	0.7
L_1	—	1.0	—

Figure K 64-Pin LQFP (PLQP0064GA-A)